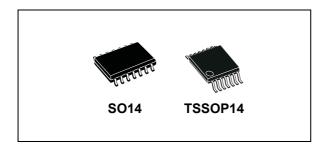


Hex Schmitt inverter

Datasheet - production data



Features

- High speed: t_{PD} = 12 ns (typ.) at V_{CC} = 6 V
- Low power dissipation:
 I_{CC} = 1 μA (max.) at T_A = 25 °C
- High noise immunity:
 V_H = 1.2 V (typ.) at V_{CC} = 6 V
- Symmetrical output impedance: |I_{OH}| = I_{OL} = 4 mA (min.)
- Balanced propagation delays: $t_{PLH} \cong t_{PHL}$

Wide operating voltage range: V_{CC} (opr) = 2 to 6 V

- Pin and function compatible with 74 series 14
- ESD performance

CDM: 1 kVHBM: 2 kVMM: 200 V

Description

The M74HC14 is a high speed CMOS hex Schmitt inverter fabricated with silicon gate C^2 MOS technology. Pin configuration and functions are the same as those of the M74HC04 but all inputs have a 20 % V_{CC} hysteresis level.

This, together with the Schmitt trigger function, allows the device to be used on line receivers with slow rise/fall input signals.

All inputs are equipped with protection circuits against static discharge and transient excess voltage.

Table 1. Device summary

Order code	Temperature range Package		Packing	Marking
M74HC14RM13TR	-55 °C to +125 °C	S014		74HC14
M74HC14YRM13TR ⁽¹⁾	-40 °C to +125 °C	SO14 (automotive grade)	Tape and reel	74HC14Y
M74HC14TTR	-55 °C to +125 °C	TSSOP14	Tape and reer	HC14
M74HC14YTTR ⁽¹⁾	-40 °C to +125 °C	TSSOP14 (automotive grade)		HC14Y

Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q002.

Contents M74HC14

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2	Functional description
3	Electrical characteristics
4	Package information
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	4.2 TSSOP14 package information
5	Ordering information1
6	Revision history

M74HC14 Pin information

1 Pin information

Figure 1. Pin connections and IEC logic symbols

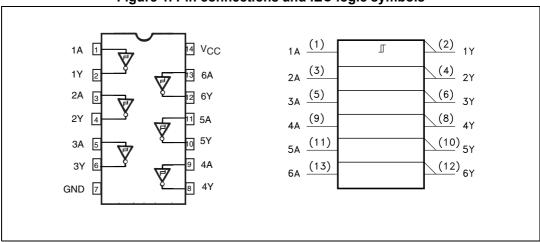


Table 2. Pin description

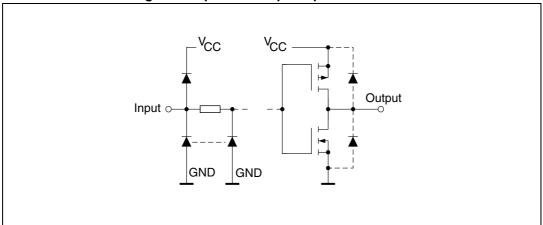
Pin number	Symbol	Name and function
1, 3, 5, 9, 11, 13	1A to 6A	Data inputs
2, 4, 6, 8, 10, 12	1Y to 6Y	Data outputs
7	GND	Ground (0 V)
14	V _{CC}	Positive supply voltage

2 Functional description

Table 3. Truth table

Α	Y
L	Н
Н	L

Figure 2. Input and output equivalent circuit



3 Electrical characteristics

Stressing the device above the ratings listed in the "Absolute maximum ratings" table may cause permanent damage to the device. These are stress ratings only, and operation of the device at these or any other conditions above those indicated in the operating sections of this specification are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Please refer to the STMicroelectronics SURE Program and other relevant quality documents.

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	-0.5 to +7	
VI	DC input voltage	-0.5 to V _{CC} + 0.5	V
V _O	DC output voltage	-0.5 to V _{CC} + 0.5	
I _{IK}	DC input diode current	±20	
I _{OK}	DC output diode current		
I _O	DC output current	±25	mA
I _{CC} or I _{GND}	DC V _{CC} or ground current	±50	
P _D	Power dissipation	500 ⁽¹⁾	mW
T _{stg}	Storage temperature	-65 to +150	°C
T _L	Lead temperature (10 sec)	300	

^{1. 500} mW at 65 °C; derate to 300 mW by 10 mW/°C from 65 °C to 85 °C

Table 5. Recommended operating conditions

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	2 to 6	
V _I	Input voltage	0 to V _{CC}	V
V _O	Output voltage	0 10 v CC	
T _{op}	Operating temperature	-55 to 125	°C

Electrical characteristics M74HC14

Table 6. DC specifications

		Te	st condition	Value							
Sym.	Parameter	V _{CC}		T _A = 25 °C			-40 to	85 °C	-55 to	125 °C	Unit
		(V)		Min	Тур	Max	Min	Max	Min	Max	
		2.0		1.0	1.28	1.5	1.0	1.5	1.0	1.5	
V_{t+}	High level input voltage	4.5		2.3	2.8	3.15	2.3	3.15	2.3	3.15	
	3.3	6.0		3.0	3.7	4.2	3.0	4.2	3.0	4.2	
		2.0		0.3	0.74	0.9	0.3	0.9	0.3	0.9	
V_{t-}	Low level input voltage	4.5		1.13	1.8	2.0	1.13	2.0	1.13	2.0	
	J	6.0		1.5	2.4	2.6	1.5	2.6	1.5	2.6	
		2.0		0.3	0.54	1.0	0.3	1.0	0.3	1.0	
V_{H}	V _H Hysteresis voltage	4.5		0.6	1.0	1.4	0.6	1.4	0.6	1.4	
		6.0		0.8	1.3	1.4	0.8	1.7	0.8	1.7	
		2.0		1.9	2.0		1.9		1.9		V
		4.5	$I_O = -20 \mu A$	4.4	4.5		4.4		4.4		
V_{OH}	High level output voltage	6.0		5.9	6.0		5.9		5.9		
	3.	4.5	I _O = -4.0 mA	4.18	4.31		4.13		4.10		
		6.0	I _O = -5.2 mA	5.68	5.8		5.63		5.60		
		2.0			0.0	0.1		0.1		0.1	
		4.5	$I_{O} = -20 \mu A$		0.0	0.1		0.1		0.1	
V _{OL}	Low level output voltage	6.0			0.0	0.1		0.1		0.1	
		4.5	I _O = -4.0 mA		0.17	0.26		0.33		0.40	
		6.0	I _O = -5.2 mA		0.18	0.26		0.33		0.40	
I _I	Input leakage current	6.0	V _I = V _{CC}			±0.1		±1		±1	μА
I _{CC}	Quiescent supply current	0.0	or GND			1		10		20	μΑ

Table 7. AC electrical characteristics ($C_1 = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

		Test condition	Value					
Sym.	Parameter	V _{CC} (V)	T _A = 25 °C		-40 to 85 °C	-55 to 125 °C	Unit	
			Тур	Max	Max	Max		
		2.0	30	75	95	110		
t _{TLH} t _{THL}	Output transition time	4.5	8	15	19	22		
		6.0	7	13	16	19	ne	
			42	125	155	190	ns	
t _{PLH} t _{PHL}	Propagation delay time	4.5	14	25	31	38		
		6.0	12	21	16	32		

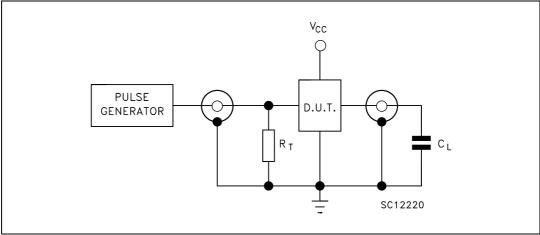
Table 8. Capacitive characteristics

		Test condition		Value				
Sym	Parameter	V _{cc}		T _A =	25°C	-40 to 85°C	-55 to 125°C	Unit
		(V)		Тур	Max	Max	Max	
C _{IN}	Input capacitance			5	10	10	10	
C _{PD}	Power dissipation capacitance ⁽¹⁾	5.0	f _{IN} = 10 MHz	28				pF

C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load (refer to test circuit). Average operating current can be obtained by the following equation:

I_{CC(opr)} = C_{PD} x V_{CC} x f_{IN} + I_{CC}/6(per gate).

Figure 3. Test circuit



Electrical characteristics M74HC14

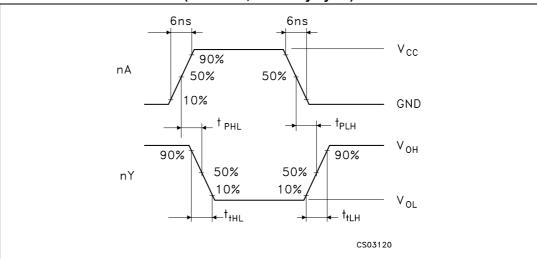


Figure 4. Waveform: propagation delay times (f = 1 MHz; 50% duty cycle)



M74HC14 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.



Package information M74HC14

4.1 SO14 package information

D A S B A S GAMS0502131027CB

Figure 5. SO14 package mechanical drawing

Table 9. SO14 package mechanical data

	Dimensions							
Ref		Millimeters		Inches				
	Min.	Тур.	Max.	Min.	Тур.	Max.		
Α			1.75			0.068		
a1	0.1		0.2	0.003		0.007		
a2			1.65			0.064		
b	0.35		0.46	0.013		0.018		
b1	0.19		0.25	0.007		0.010		
С		0.5			0.019			
c1		45 °			45 °			
D	8.55		8.75	0.336		0.344		
E	5.8		6.2	0.228		0.244		
е		1.27			0.050			
e3		7.62			0.300			
F	3.8		4.0	0.149		0.157		
G	4.6		5.3	0.181		0.208		
L	0.5		1.27	0.019		0.050		
М			0.68			0.026		
S			8 °			8 °		

M74HC14 Package information

Figure 6. SO14 tape and reel information

1. Drawing is not to scale

Table 10. SO14 tape and reel information

	Dimensions						
Ref	Millin	neters	Inches				
	Min. Max.		Min.	Max.			
А		330		12.992			
С	12.8	13.2	0.504	0.519			
D	20.2		0.795				
N	60		2.362				
Т		22.4		0.882			
Ao	6.4	6.6	0.252	0.260			
Во	9	9.2	0.354	0.362			
Ko	2.1	2.3	0.082	0.090			
Po	3.9	4.1	0.153	0.161			
Р	7.9	8.1	0.311	0.319			

Package information M74HC14

4.2 TSSOP14 package information

Figure 7. TSSOP14 package mechanical drawing

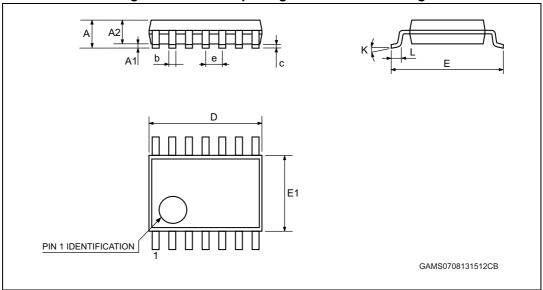


Table 11. TSSOP14 package mechanical data

	Dimensions								
Ref		Millimeters		Inches					
	Min.	Тур.	Max.	Min.	Тур.	Max.			
Α			1.2			0.047			
A1	0.05		0.15	0.002	0.004	0.006			
A2	0.8	1	1.05	0.031	0.039	0.041			
b	0.19		0.30	0.007		0.012			
С	0.09		0.20	0.004		0.0089			
D	4.9	5	5.1	0.193	0.197	0.201			
Е	6.2	6.4	6.6	0.244	0.252	0.260			
E1	4.3	4.4	4.48	0.169	0.173	0.176			
е		0.65			0.0256				
K	0°		8°	0°		8°			
L	0.45	0.60	0.75	0.018	0.024	0.030			

M74HC14 Package information

PIN 1 IDENTIFICATION

GAMS0708131512CB

Figure 8. TSSOP14 tape and reel information

1. Drawing is not to scale

Table 12. TSSOP14 tape and reel information

	Dimensions					
Ref	Millimeters		Inches			
	Min.	Max.	Min.	Max.		
Α		330		12.992		
С	12.8	13.2	0.504	0.519		
D	20.2		0.795			
N	60		2.362			
Т		22.4		0.882		
Ao	6.7	6.9	0.264	0.272		
Во	5.3	5.5	0.209	0.217		
Ko	1.6	1.8	0.063	0.071		
Po	3.9	4.1	0.153	0.161		
Р	7.9	8.1	0.311	0.319		

Ordering information M74HC14

5 Ordering information

Table 13. Order codes

Order code	Temperature range	Package	Packing	Marking
M74HC14RM13TR	-55 °C to +125 °C	S014		74HC14
M74HC14YRM13TR ⁽¹⁾	-40 °C to +125 °C	SO14 (automotive grade)	Tano and rool	74HC14Y
M74HC14TTR	-55 °C to +125 °C	TSSOP14	Tape and reel	HC14
M74HC14YTTR ⁽¹⁾	-40 °C to +125 °C	TSSOP14 (automotive grade)		HC14Y

Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q002.

6 Revision history

Table 14. Document revision history

Date	Revision	Changes
01-Jul-2001	1	Initial release.
23-May-2008	2	Document converted and restructured to new template. Removed: M74HC14M1R order code. Added: tape and reel specifications for SO-14 and TSSOP14 packages.
09-Aug-2013	3	Features: added ESD information Table 1: Device summary: added automotive grade order codes. Added Section 5: Ordering information.
13-Jan-2014	4	Removed DIP14 package Table 1: Device summary and Table 13: Order codes: added "Temperature range" and "Marking"; updated 1.

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